

Data Sheet May 31, 2006 FN7436.4

## Micropower Single Supply Rail-to-Rail Input-Output Precision Op Amp

The EL8176 is a micropower precision operational amplifier optimized for single supply operation at 5V and can operate down to 2.4V.

The EL8176 draws minimal supply current while meeting excellent DC-accuracy noise and output drive specifications. Competing devices seriously degrade these parameters to achieve micropower supply current. Offset current, voltage and current noise, slew rate, and gain-bandwidth product are all two to ten times better than on previous micropower op-amps.

The EL8176 can be operated from one lithium cell or two Ni-Cd batteries. The input range includes both positive and negative rail. The output swings to both rails.

## Ordering Information

	DART	TABE 0		DICO		
PART NUMBER	PART MARKING	TAPE & REEL	PACKAGE	PKG. DWG.#		
EL8176AIW-T7	BBGA	7" (3K pcs)	6 Ld SOT-23	MDP0038		
EL8176AIW-T7A	BBGA	7" (250 pcs)	6 Ld SOT-23	MDP0038		
EL8176AIWZ-T7 (Note)	BBNA	7" (3K pcs)	6 Ld SOT-23 (Pb-free)	MDP0038		
EL8176AIWZ-T7A (Note)	BBNA	7" (250 pcs)	6 Ld SOT-23 (Pb-free)	MDP0038		
EL8176BIW-T7	BBGA	7" (3K pcs)	6 Ld SOT-23	MDP0038		
EL8176BIW-T7A	BBGA	7" (250 pcs)	6 Ld SOT-23	MDP0038		
EL8176BIWZ-T7 (Note)	BBNA	7" (3K pcs)	6 Ld SOT-23 (Pb-free)	MDP0038		
EL8176BIWZ-T7A (Note)	BBNA	7" (250 pcs)	6 Ld SOT-23 (Pb-free)	MDP0038		
EL8176ISZ (Note)	8176ISZ	-	8 Ld SO (Pb-free)	MDP0027		
EL8176ISZ-T7 (Note)	8176ISZ	7"	8 Ld SO (Pb-free)	MDP0027		
EL8176ISZ-T13 (Note)	8176ISZ	13"	8 Ld SO (Pb-free)	MDP0027		

NOTE: Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

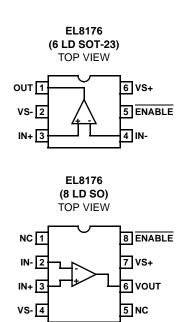
#### **Features**

- 55µA supply current
- 100µV max offset voltage
- 500pA input bias current
- · 400kHz gain-bandwidth product
- 1MHz -3dB bandwidth
- 0.13V/µs slew rate
- Single supply operation down to 2.4V
- Rail-to-rail input and output
- · Output sources and sinks 26mA load current
- Pb-free plus anneal available (RoHS compliant)

## **Applications**

- · Battery- or solar-powered systems
- · 4mA to 20mA current loops
- · Handheld consumer products
- Medical devices
- Thermocouple amplifiers
- · Photodiode pre amps
- · pH probe amplifiers

#### **Pinouts**



## **Absolute Maximum Ratings** $(T_A = 25^{\circ}C)$

Supply Voltage	Output Short-Circuit Duration
Differential Input Voltage	Ambient Operating Temperature Range40°C to +125°C
Current into I <sub>N</sub> +, I <sub>N</sub> -, and ENABLE	Storage Temperature Range65°C to +150°C
Input Voltage 0.5V to V <sub>S</sub> +0.5V	Operating Junction Temperature

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typical values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore:  $T_J = T_C = T_A$ 

# **Electrical Specifications** $V_S = 5V$ , 0V, $V_{CM} = 0.1V$ , $V_O = 1.4V$ , $T_A = 25$ °C unless otherwise specified. **Boldface limits** apply over the operating temperature range, -40°C to +125°C.

PARAMETER	DESCRIPTION	CONDITION	s	MIN	TYP	MAX	UNIT
Vos	Input Offset Voltage			-100	50	100	μV
			EL8176ISZ			220	μV
$\frac{\Delta V_{OS}}{\Delta Time}$	Long Term Input Offset Voltage Stability		EL8176AIW/AIWZ, EL8176BIW/BIWZ		1.2		μV/Mo
			EL8176ISZ		2.4		μV/Mo
$\frac{\Delta V_{OS}}{\Delta T}$	Input Offset Drift vs Temperature		EL8176AIW/AIWZ, EL8176BIW/BIWZ		0.3		μV/°C
			EL8176ISZ		0.7	1.4	μV/°C
I <sub>OS</sub>	Input Offset Current				0.4	1	nA
			EL8176ISZ			1.5	nA
I <sub>B</sub>	Input Bias Current				0.5	1.5	nA
			EL8176ISZ			3.0	nA
e <sub>N</sub>	Input Noise Voltage Peak-to- Peak	f = 0.1Hz to 10Hz	'		1		μV <sub>PP</sub>
	Input Noise Voltage Density		25		nV <b>/</b> √Hz		
i <sub>N</sub>	Input Noise Current Density	f <sub>O</sub> = 1kHz			0.1		pA <b>/</b> √Hz
CMIR	Input Voltage Range	Guaranteed by CMRR test		0		5	V
CMRR	Common-Mode Rejection	V <sub>CM</sub> = 0V to 5V		90	110		dB
	Ratio		EL8176ISZ	90			dB
PSRR	Power Supply Rejection Ratio	V <sub>S</sub> = 2.4V to 5V		90	110		dB
			EL8176ISZ	90			dB
A <sub>VOL</sub>	Large Signal Voltage Gain	$V_{O} = 0.5V \text{ to } 4.5V, R_{L} = 100k\Omega$		200	500		V/mV
			EL8176ISZ	200			V/mV
		$V_O = 0.5V$ to 4.5V, $R_L = 1k\Omega$			25		V/mV
V <sub>OUT</sub>	Maximum Output Voltage	VOL; Output low, $R_L = 100k\Omega$			3	8	mV
	Swing		EL8176ISZ			10	mV
		VOL; Output low, $R_L = 1k\Omega$			130	200	mV
			EL8176ISZ			300	mV
		VOH; Output high, $R_L = 100 k\Omega$		4.994	4.997		V
			EL8176ISZ	4.992			V
		VOH; Output high, $R_L = 1k\Omega$		4.750	4.867		V
			EL8176ISZ	4.7			V

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**Electrical Specifications**  $V_S = 5V$ , 0V,  $V_{CM} = 0.1V$ ,  $V_O = 1.4V$ ,  $T_A = 25$ °C unless otherwise specified. **Boldface limits** apply over the operating temperature range, -40°C to +125°C. **(Continued)** 

PARAMETER	DESCRIPTION	CONDITIONS		MIN	TYP	MAX	UNIT
SR	Slew Rate		0.065	0.13	0.2	V/µs	
GBW	Gain Bandwidth Product	f <sub>O</sub> = 100kHz			400		kHz
BW	-3dB Bandwidth	Unity gain, C <sub>LOAD</sub> = 27pF, R <sub>F</sub> = 100	ΟΩ		1		MHz
I <sub>S,ON</sub>	Supply Current, Enabled			35	55	75	μA
			EL8176ISZ	30		90	μA
I <sub>S,OFF</sub>	Supply Current, Disabled				3	10	μA
			EL8176ISZ			10	μA
I <sub>O</sub> +	Short Circuit Output Sourcing Current	$R_L = 10\Omega$		18	31		mA
			EL8176ISZ	18			mA
I <sub>O</sub> -	Short Circuit Output Sinking	$R_L = 10\Omega$		17	26		mA
	Current		EL8176ISZ	15			mA
V <sub>S</sub>	Minimum Supply Voltage				2.2	2.4	V
			EL8176ISZ			2.4	V
V <sub>INH</sub>	Enable Pin High Level		<u>'</u>			2	V
V <sub>INL</sub>	Enable Pin Low Level			0.8			V
I <sub>ENH</sub>	Enable Pin Input Current	V <sub>EN</sub> = 5V		0.25	0.7	2.0	μΑ
			EL8176ISZ			2.5	μΑ
I <sub>ENL</sub>	Enable Pin Input Current	V <sub>EN</sub> = 0V		-0.5	0	+0.5	μΑ
			EL8176ISZ	-0.5		+0.5	μA

## **Typical Performance Curves**

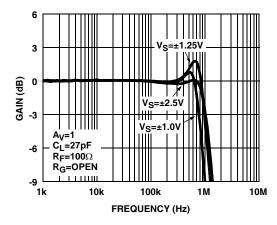


FIGURE 1. UNITY GAIN FREQUENCY RESPONSE vs SUPPLY VOLTAGE

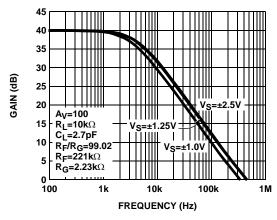


FIGURE 2. FREQUENCY RESPONSE vs SUPPLY VOLTAGE

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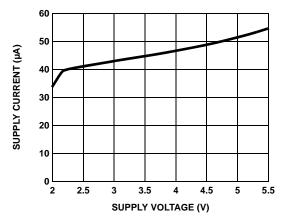


FIGURE 3. SUPPLY CURRENT vs SUPPLY VOLTAGE

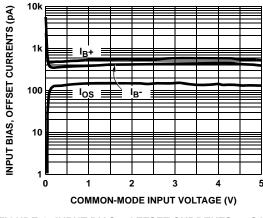


FIGURE 4. INPUT BIAS + OFFSET CURRENTS vs COMMON-MODE INPUT VOLTAGE

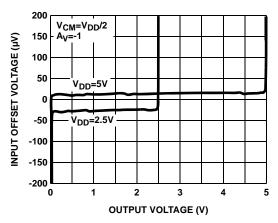


FIGURE 5. INPUT OFFSET VOLTAGE vs OUTPUT VOLTAGE

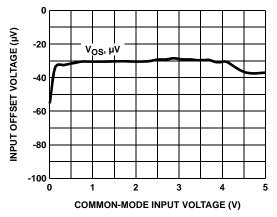


FIGURE 6. INPUT OFFSET VOLTAGE vs COMMON-MODE INPUT VOLTAGE

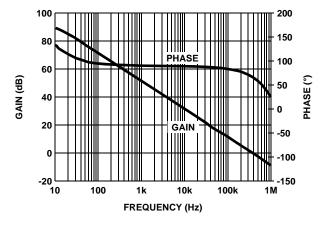


FIGURE 7. A<sub>VOL</sub> vs FREQUENCY @  $1k\Omega$  LOAD

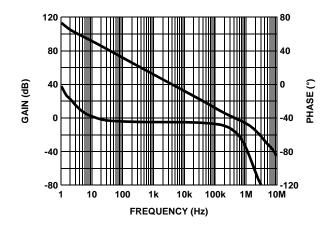


FIGURE 8. A<sub>VOL</sub> vs FREQUENCY @  $100k\Omega$  LOAD

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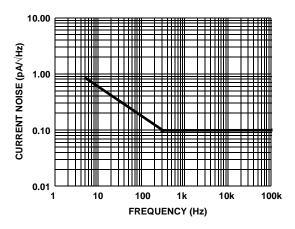


FIGURE 9. CURRENT NOISE vs FREQUENCY

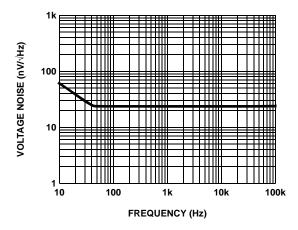


FIGURE 10. VOLTAGE NOISE vs FREQUENCY

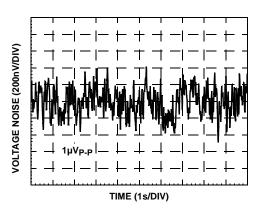


FIGURE 11. 0.1Hz TO 10Hz INPUT VOLTAGE NOISE

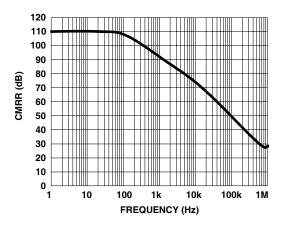


FIGURE 12. CMRR vs FREQUENCY

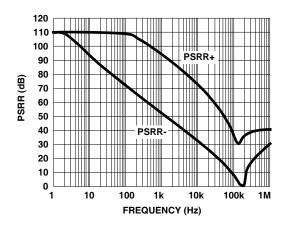


FIGURE 13. PSRR vs FREQUENCY

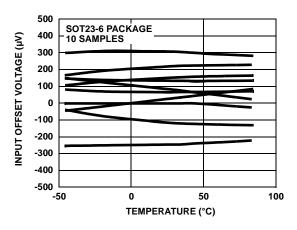


FIGURE 14. VOS vs TEMPERATURE

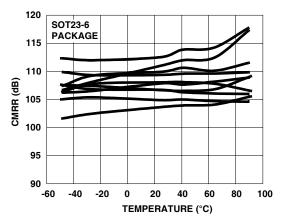


FIGURE 16. CMRR vs TEMPERATURE

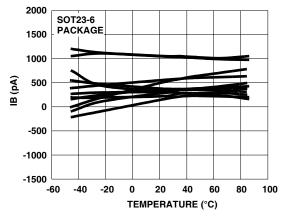


FIGURE 18. IB vs TEMPERATURE

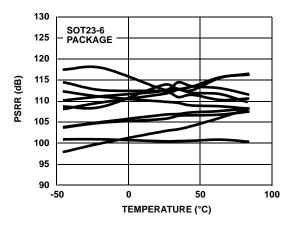


FIGURE 15. PSRR vs TEMPERATURE

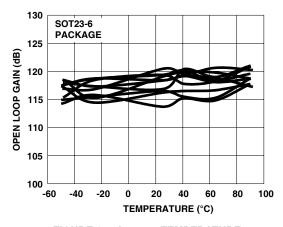


FIGURE 17. A<sub>VOL</sub> vs TEMPERATURE

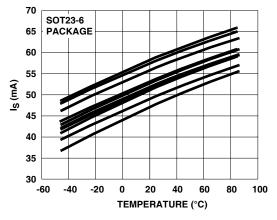


FIGURE 19.  $I_S$  vs TEMPERATURE

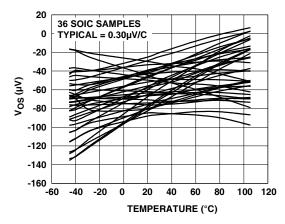


FIGURE 20. EL8176 SOIC  $V_{OS}$  vs TEMPERATURE ( $V_{S} = 5V$ )

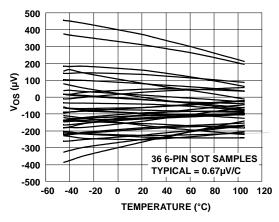


FIGURE 21. EL8176 SOT  $V_{OS}$  vs TEMPERATURE ( $V_{S} = 5V$ )

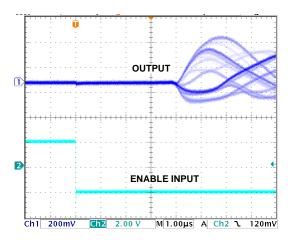


FIGURE 22. ENABLE DELAY TIME

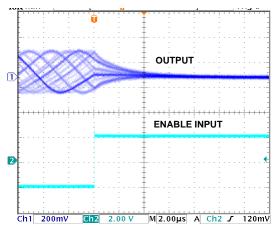


FIGURE 23. DISABLE DELAY TIME

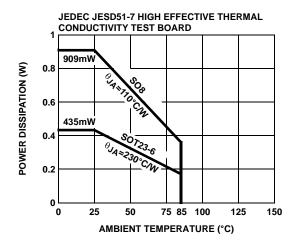


FIGURE 24. PACKAGE POWER DISSIPATION VS AMBIENT TEMPERATURE

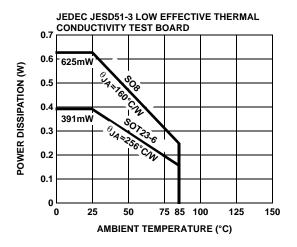


FIGURE 25. PACKAGE POWER DISSIPATION VS AMBIENT TEMPERATURE

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## Applications Information

#### Introduction

The EL8176 is a rail-to-rail input and output micro-power precision single supply operational amplifier with an enable feature. The device achieves rail-to-rail input and output operation and eliminates the concerns introduced by a conventional rail-to-rail I/O operational amplifier.

#### Rail-to-Rail Input

The input common-mode voltage range of the EL8176 goes from negative supply to positive supply without introducing offset errors or degrading performance associated with a conventional rail-to-rail input operational amplifier. Many rail-to-rail input stages use two differential input pairs, a long-tail PNP (or PFET) and an NPN (or NFET). Severe penalties have to be paid for this circuit topology. As the input signal moves from one supply rail to another, the operational amplifier switches from one input pair to the other causing drastic changes in input offset voltage and an undesired change in magnitude and polarity of input offset current.

The EL8176 achieves input rail-to-rail without sacrificing important precision specifications and without degrading distortion performance. The EL8176's input offset voltage exhibits a smooth behavior throughout the entire common-mode input range. The input bias current versus the common-mode voltage range for the EL8176 gives us an undistorted behavior from typically 10mV above the negative rail all the way up to the positive rail. 10mV above the negative rail to the positive rail is the range of operation of yet another feature of the EL8176, input bias current compensation.

#### Input Bias Current Compensation

The input bias currents of the EL8176 are decimated down to a typical of 500pA while maintaining an excellent bandwidth for a micro-power operational amplifier. Inside the EL8176 is an input bias canceling circuit. The input stage transistors are still biased with an adequate current for speed but the canceling circuit sinks most of the base current, leaving a small fraction as input bias current. The input bias current compensation/cancellation operates from typically 10mV to the positive supply rail and also from -40°C to 85°C.

#### Rail-to-Rail Output

A pair of complementary MOSFET devices achieves rail-to-rail output swing. The NMOS sinks current to swing the output in the negative direction. The PMOS sources current to swing the output in the positive direction. The EL8176 with a  $100 \text{k}\Omega$  load will swing to within 3mV of the supply rails.

#### Enable/Disable Feature

The EL8176 offers an EN pin. The active low enable pin disables the device when pulled up to at least 2.2V. Upon

disable the part consumes typically  $3\mu A$ , while the output is in a high impedance state. The EN also has an internal pull-down. If left open, the EN pin will pull to negative rail and the device will be enabled by default. The high impedance at output during disable allows multiple EL8176s to be connected together as a MUX. The outputs are tied together in parallel and a channel can be selected by the EN pin.

#### **Proper Layout Maximizes Performance**

To achieve the maximum performance of the high input impedance and low offset voltage of the EL8176, care should be taken in the circuit board layout. The PC board surface must remain clean and free of moisture to avoid leakage currents between adjacent traces. Surface coating of the circuit board will reduce surface moisture and provide a humidity barrier, reducing parasitic resistance on the board. The use of guard rings around the amplifier inputs will further reduce leakage currents. Figure 26 shows how the guard ring should be configured and Figure 27 shows the top view of how a surface mount layout can be arranged. The guard ring does not need to be a specific width, but it should form a continuous loop around both inputs. By setting the guard ring voltage equal to the voltage at the non-inverting input, parasitic capacitance is minimized as well. For further reduction of leakage currents, components can be mounted to the PC board using Teflon standoff insulators.

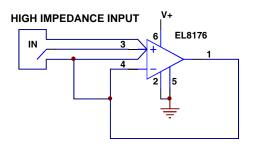


FIGURE 26.

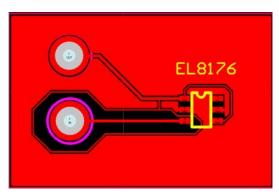


FIGURE 27.

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## **Typical Applications**

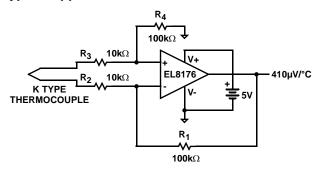
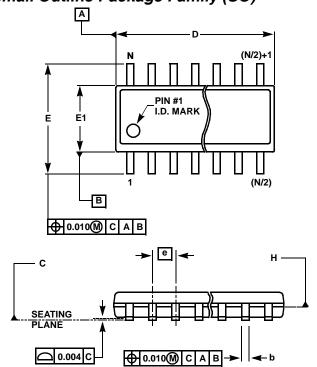
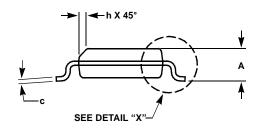


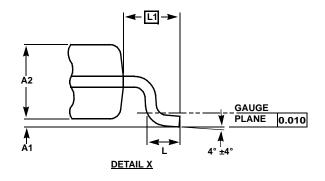
FIGURE 28. THERMOCOUPLE AMPLIFIER

Thermocouples are the most popular temperature-sensing device because of their low cost, interchangeability, and ability to measure a wide range of temperatures. The EL8176 is used to convert the differential thermocouple voltage into single-ended signal with 10X gain. The EL8176's rail-to-rail input characteristic allows the thermocouple to be biased at ground and the converter to run from a single 5V supply.

# Small Outline Package Family (SO)







## **MDP0027**

#### **SMALL OUTLINE PACKAGE FAMILY (SO)**

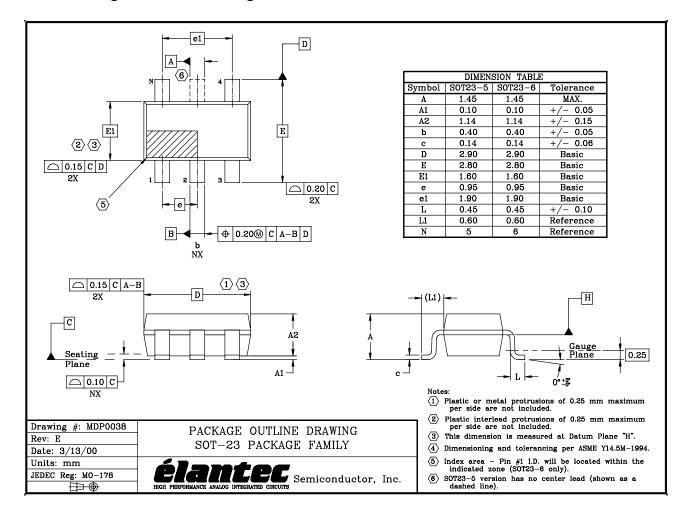
			SO16	SO16 (0.300")	SO20	SO24	SO28		
SYMBOL	SO-8	SO-14	(0.150")	(SOL-16)	(SOL-20)	(SOL-24)	(SOL-28)	TOLERANCE	NOTES
Α	0.068	0.068	0.068	0.104	0.104	0.104	0.104	MAX	-
A1	0.006	0.006	0.006	0.007	0.007	0.007	0.007	±0.003	-
A2	0.057	0.057	0.057	0.092	0.092	0.092	0.092	±0.002	-
b	0.017	0.017	0.017	0.017	0.017	0.017	0.017	±0.003	-
С	0.009	0.009	0.009	0.011	0.011	0.011	0.011	±0.001	-
D	0.193	0.341	0.390	0.406	0.504	0.606	0.704	±0.004	1, 3
Е	0.236	0.236	0.236	0.406	0.406	0.406	0.406	±0.008	-
E1	0.154	0.154	0.154	0.295	0.295	0.295	0.295	±0.004	2, 3
е	0.050	0.050	0.050	0.050	0.050	0.050	0.050	Basic	-
L	0.025	0.025	0.025	0.030	0.030	0.030	0.030	±0.009	-
L1	0.041	0.041	0.041	0.056	0.056	0.056	0.056	Basic	-
h	0.013	0.013	0.013	0.020	0.020	0.020	0.020	Reference	-
N	8	14	16	16	20	24	28	Reference	-

Rev. L 2/01

### NOTES:

- 1. Plastic or metal protrusions of 0.006" maximum per side are not included.
- 2. Plastic interlead protrusions of 0.010" maximum per side are not included.
- 3. Dimensions "D" and "E1" are measured at Datum Plane "H".
- 4. Dimensioning and tolerancing per ASME Y14.5M-1994

## SOT-23 Package Outline Drawing



NOTE: The package drawing shown here may not be the latest version. To check the latest revision, please refer to the Intersil website at http://www.intersil.com/design/packages/index.asp

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